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OSP EXPO and TIA's GLOBALCOMM Announce 2006 Co-location to Serve Converging Communications Industry

June 5-8, 2006 McCormick Place, Chicago

Alexandria, VA — June 2, 2005 – The Telecommunications Industry Association (TIA) and OSP EXPO today announced the co-location of OSP EXPO, the broadband deployment marketplace, with GLOBALCOMM™, the next-generation communications marketplace and summit, June 5-8, 2006, McCormick Place, Chicago.

GLOBALCOMM will bring together a broad base of global information and communications technology (ICT) suppliers, service providers, enterprises and other users of ICT. The event will feature world-class educational sessions and cutting-edge technology solutions for convergence, communications infrastructure, wireless, content, enhanced security and IP applications such as IPTV, VoIP and VoD. Along with keynotes from global industry leaders, GLOBALCOMM will offer technology, regulatory and business advancements driving the converged, global telecommunications industry.

OSP EXPO, the industry leader in telecom network education, will bring together OSP professionals from the ILEC, IOC and CLEC communities delivering demonstrations of over 250 of the latest OSP technologies, more than 50+ regular and advanced seminars offering attendees the opportunity to receive continuing education credits, powerful keynotes by top SBC Network executives, networking opportunities and more. The OSP EXPO is a must-attend for any deployment professional seeking FTTI and FTTP strategies, or upgrading legacy plant to deliver the triple play.

"We are thrilled to offer the industry the breadth and depth of technologies and programming this co-location will provide," said TIA President Matthew J. Flanagan. "With the leading outside plant exhibition under the same roof as GLOBALCOMM, the latest communications solutions from network convergence to end user deployment will be on display."

"We have a long standing relationship with TIA and are pleased with our agreement to co-locate in Chicago," said Judith Chance, President of Practical Communications, owner of OSP EXPO. "The co-location agreement will give us the opportunity to bring two distinct segments of the telecom industry to our exhibitors, and the power of two related shows all in one location to serve the converging telecom industry."

About TIA TIA is the leading trade organization serving the information and communications technology (ICT) industry. Through its worldwide activities, TIA facilitates business development opportunities and a competitive market environment. Owner and producer of GLOBALCOMM, TIA represents ICT suppliers serving global markets through its leadership in standards development, domestic and international policy advocacy, and facilitating member business opportunities. TIA represents the communications sector of the Electronic Industries Alliance (EIA). Visit us at <http://www.tiaonline.org>.

GLOBALCOMM™ is a trademark of the Telecommunications Industry Association (TIA). The Next-Generation Communications Marketplace and Summit will take place June 5-8, 2006, at Chicago's McCormick Place. www.globalcomm2006.com

About OSP EXPO OSP EXPO is owned by Practical Communications Incorporated (PCI), a world class publisher of technology information resources, dedicated to advancing technology businesses with niched magazines and trade shows. The OSP EXPO 2005 is the telecom industry's only "how-to" educational trade show showcasing more than 250 exhibitors, over 50 regular and advanced paid seminars offering attendees the opportunity to receive continuing education credits. The Broadband Deployment Marketplace, OSP EXPO, will take place June 5-8, 2006 at Chicago's McCormick Place. For more information call 847.462.5760 or visit ospmag.com/expo.

